



## Soft Materials

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Deadline for manuscript  
submissions:

**closed (31 October 2021)**

### Message from the Guest Editor

Dear Colleagues,

Soft materials is an increasingly active field of research driving science and technology into new exciting directions. Large deformations coupled with various multiphysics phenomena and instabilities at different length scales open an immensely rich research arena. This offers unique opportunities to develop multifunctional materials and devices with novel properties, through the targeted design of material composition and microstructural geometry. Moreover, soft materials represent essential components in biological tissues, a topic of extreme interest for bio-medical applications.

This Special Issue will focus on recent experimental, computational, theoretical and manufacturing advances in the broad field of Soft Materials.

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Prof. Dr. Stephan Rudykh  
Guest Editor





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## Message from the Editor-in-Chief

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